

MECHANICAL DATA

Module dimension

Viewing area

Active area

Dot size

Dot pitch

Mounting hole

ITEM

STANDARD VALUE

26.7 x 19.26 x 1.65

23.938 x 12.058 21.738 x 10.858

0.148 x 0.148

0.17 x 0.17

n/a

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UNIT

mm



- Type: graphic
- Display format: 128 x 64 dots
- Built-in controller: SSD1306BZ
- Duty cycle: 1/64
- +3 V power supply
- Interface: 6800, 8080, serial, and I²C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

ABSOLUTE MAXIMUM RATINGS									
ITEM	SYMBOL	STANDAF	RD VALUE	UNIT					
	STINDUL	MIN.	MAX.						
Supply voltage for logic ⁽¹⁾⁽²⁾	V _{DD}	0	4	V					
Supply voltage for display ⁽¹⁾⁽²⁾	V _{CC}	0	15	v					
Operating temperature	T _{OP}	-40	+80	°C					
Storage temperature	T _{STG}	-40	+80	U					

Notes

- ⁽¹⁾ All the above voltages are on the basis of " $V_{SS} = 0 V$ ".
- ⁽²⁾ When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

ELECTRICAL CHARACTERISTICS									
ITEM	SYMBOL	CONDITION	ST	ANDARD VA	LUE	UNIT			
	STMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT			
Supply voltage for logic	V _{DD}	-	2.8	3.0	3.3				
Supply voltage for display	V _{CC}	-	10	12	15				
Input high voltage	V _{IH}	-	0.8 V _{DD}	-	V _{DDI/O}	V			
Input low voltage	V _{IL}	-	0	-	0.2 V _{DD}	v			
Output high voltage	V _{OH}	-	0.9 V _{DD}	-	V _{DDI/O}				
Output low voltage	V _{OL}	-	0	-	0.1 V _{DD}				
50 % check board operating current	I _{CC}	V _{CC} = 12 V	9	10	12	mA			
CIEx (white)		(CIE1931)	0.26	0.28	0.30				
CIEy (white)		(CIE1931)	0.30	0.32	0.34				

OPTIONS

EMITTING COLOR								
YELLOW	GREEN	BLUE	WHITE					
-	_	-	-	Yes				

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For technical questions, contact: displays@vishay.com

Document Number: 37905

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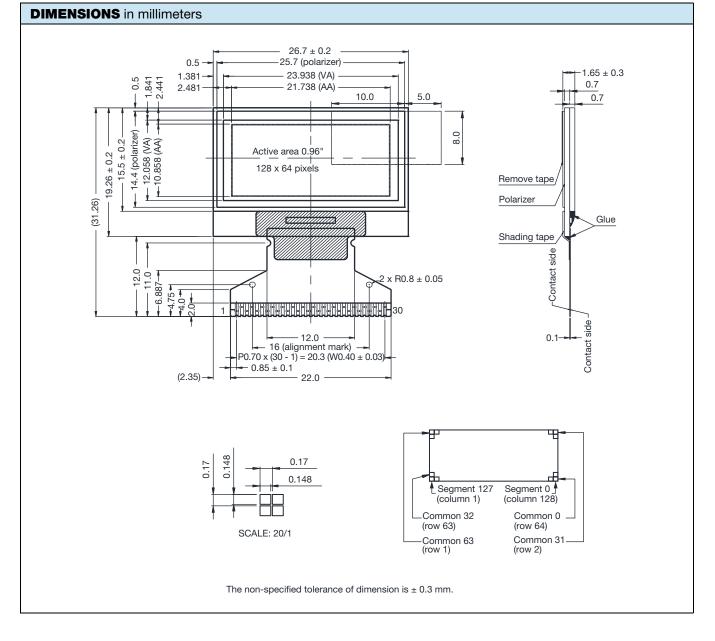
INTERFACE	PIN FUNCTION

	FACE PIN	FUNCT									
PIN NO.	SYMBOL				FUNCTION						
1	NC (GND)	The suppo	Reserved pin (supporting pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.								
2	C2N	Positive te	Positive terminal of the flying inverting capacitor negative terminal of the flying boost capacitor								
3	C2P					/ must be floated whe					
4	C1P C1N	used.				,					
5	CIN	-									
6	V _{BAT}	This is the		the internal buffer o		converter. It must be on the converter is not					
7	NC	NC									
8	V _{SS}		logic circuit round pin. It also act	s as a reference for	the logic pins. It mu	st be connected to ex	ternal ground.				
9	V _{DD}		ply for logic bltage supply pin. It	must be connected	to external source.						
10	BS0		ating protocol select are MCU interface		the following table:						
	DO4		l ² C	3-wire SPI	4-wire SPI	8-bit 68XX parallel	8-bit 80XX parallel				
11	BS1	BS0	0	1	0	0	0				
		BS1	1	0	0	0	1				
12	BS2			-	-						
.=	201	BS2	0	0	0	1	1				
13	CS#	Chip selec This pin is		t. The chip is enable	ed for MCU commur	ication only when CS	# is pulled low.				
14	RES#		et for controller and reset signal input. V		initialization of the c	hip is executed.					
15	D / C#	This pin is When the p to MCU int interface n	oin is pulled low, the erface signals, pleas node is selected, th	input at D7 to D0 w se refer to the timing e data at SDIN is t	ill be transferred to the characteristics diagonates the characteristics diagonates are the characteristics diagonates and the characteristics diagonates are characteristics and the characteristics are characteristics and the characteristics are characteristic	input at D7 to D0 is tr ne command register. rrams. When the pin is n it is pulled low, the) for slave address sel	For detail relationship pulled high and seria data at SDIN will be				
16	R / W#	Read / writ This pin is write (R/W When 80X	te select or write MCU interface inpu #) selection input. P	t. When interfacing ull this pin to "high" selected, this pin wi	to a 68XX-series mid for read mode and I	croprocessor, this pin cull it to "low" for write input. Data write oper	will be used as read e mode.				
17	E / RD#	This pin is enable (E) When con	signal. Read / write	operation is initiated -microprocessor, th	d when this pin is pu his pin receives the	nicroprocessor, this p lled high and the CS# read (RD#) signal. D	is pulled low.				
18 to 25	D0 to D7	These pins is selected	l, D1 will be the ser D2 and D1 should b	ial data input SDIN	and D0 will be the	croprocessor's data b serial clock input SCL nd SDA _{in} in applicatio	K. When I ² C mode is				
26	I _{REF}				r should be connect	ed between this pin ar	nd V _{SS} . Set the curren				
27	V _{COMH}	0		0	level for COM signals	s. A capacitor should b	e connected betweer				
28	V _{CC}	This is the				apacitor should be co nal source when the c					
		Ground of	an al an aine sit								
29	V _{LSS}		analog circuit analog ground pin. I	t should be connect	ed to V _{SS} externally.						

Revision: 14-Dec-16

Document Number: 37905









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1.Module Classification Information

<u>OLED 128 O 064 D W P P 3 N 0 0 000</u>

0	Ø ()	❹	5	Ô	Q	ð	9	10	11	12	(13)
1	Brand: Vishay Int	Brand: Vishay Intertechnology, Inc.									
2	Horizontal Format:	Horizontal Format: 128 Columns									
3	Display Type: N→0	Charact	er Typ	e, H→	Graph	іс Тур	be, Y-	→Tab [·]	Туре,	O→C	og Type
4	Vertical Format: 64	Lines									
5	Serials code										
		A	: Amb	er			R	: RE	D		
6	Emitting Color	В	: Blue				V	∕∶Wł	nite		
		G	: Gree	en			L	: Yell	ow		
7	Polarizer	Р	: With	Polariz	zer; N	: With	out P	olarize	ər		
8	Display Mode	Р	: Pass	sive Ma	atrix ; /	4: Act	ive Ma	atrix			
9	Driver Voltage	3:	3.0 V;	5: 5.0	V						
10	Touch Panel	Ν	: With	out tou	ich pa	nel; T	: With	touch	n pane	əl	
11	Products type	1. 2. 3.	 0 : Standard type 1. Sunlight Readable type 2. Transparent OLED (TOLED) 3. Flexible OLED 4. OLED for Lighting 								
12	Product grades	0 2 3 4	Product grades: 0 : Standard(A-level) 2 : B-level 3 : C-level 4 : high class(AA-level) 5 : Customer offerings								
13	Serial No.	Ap	oplicati	on ser	ial nur	nber(000~2	ZZZ)			

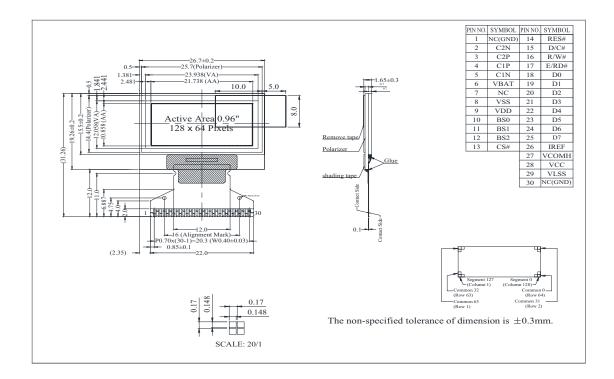


2.General Specification

ltem	Dimension	Unit				
Dot Martix	128 x 64 Dots	_				
Module dimension	26.7× 19.26 × 1.65	mm				
Active Area	21.738×10.858	mm				
Pixel Size	0.148 × 0.148	mm				
Pixel Pitch	0.17 × 0.17	mm				
Display Mode	Passive Matrix					
Display Color	White					
Drive Duty	1/64 Duty					
IC	SSD1306BZ					

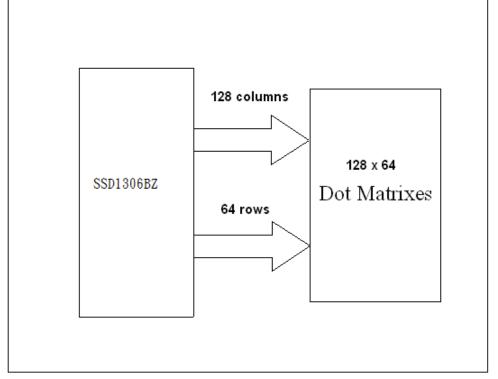


3. Contour Drawing & Block Diagram





FUNCTION BLOCK DIAGRAM



*For more information, please refer to Application Note provided by Vishay



4. Interface Pin Function

No.	Symbol	Function							
	N.C.	Reserved Pin (Supp	orting P	in)					
1	(GND)		The supporting pins can reduce the influences from stresses on the						
		function pins. These	pins mu	ust be co	onnected	d to external ground.			
2	C2N	Positive Terminal of	the Flyi	ng Inver	ting Cap	pacitorr Negative Terminal of			
3	C2P	the Flying Boost Ca	pacitor T	he char	ge-pum	o capacitors are required			
4	C1P		ls. They	must be	e floated	I when the converter is not			
5	C1N	used.							
		Power Supply for DO							
6	VBAT					ouffer of the DC/DC voltage			
Ŭ	V D/ (1					source when the converter is			
			onnected	d to VDE) when t	he converter is not used.			
7	NC	NC							
		Ground of Logic Circ							
8	VSS				erence fo	or the logic pins. It must be			
		connected to externa	-	d.					
9	VDD	Power Supply for Lo		14					
					be conn	ected to external source.			
10	BS0	Communicating Pro			tion inni	t. Cootho			
10	030	These pins are MCL	Interna	ce selec	lion inpl	il. See lhe			
		following table:	DCO	DC1	BS2	t			
11	BS1	I2C	BS0 0	BS1 1	0				
		3-wire SPI	1	0	ō				
		4-wire SPI	0	0	0				
12	BS2	8-bit 68XX Parallel	0	0	1				
		8-bit 80XX Parallel	0	1	1				
		Chip Select							
13	CS#	This pin is the chip s			•				
		communication only							
		Power Reset for Col							
14	RES#		iai input	. vvnen t	ne pin is	s low, initialization of the chip			
			trol						
				ontrol ni	in Whor	the pip is pulled high the			
		•							
15	D/C#	-			•				
			•			5			
					0				
15	D/C#	is executed. Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCLL interface signals							

8 For technical questions, contact: <u>displays@vishay.com</u>



16	R/\/#	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
17	E/RD#	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
18~25	D0~D7	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is selected, D2 & D1 should be tired together and serve as SDAout & SDAin in application and D0 is the serial clock input SCL.
26	IREF	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 12.5µA.
27	VCOMH	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
28	VCC	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and VSS when the converter is used. It must be connected to external source when the converter is not used.
29	VLSS	<i>Ground of Analog Circuit</i> This is an analog ground pin. It should be connected to VSS externally.
30	NC(GN D)	Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.



5.Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	0	4	V	1,2
Supply Voltage for Display	VCC	0	15	V	1,2
Operating Temperature	ТОР	-40	+80	°C	—
Storage Temperature	TSTG	-40	+80	°C	

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6."Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.





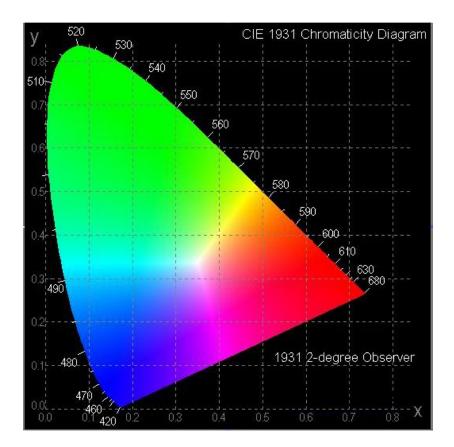
6.Electrical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	10	12	15	V
Input High Volt.	VIH	—	0.8×VDD	_	VDDIO	V
Input Low Volt.	VIL	—	0	_	0.2×VDD	V
Output High Volt.	VOH	—	0.9×VDD	_	VDDIO	V
Output Low Volt.	VOL	—	0	_	0.1×VDD	V
Operating Current for VCC (VCC Supplied Externally)	ICC	Vcc =12V	9	10	12	mA



7.Optical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
View Apple	(V)θ		160			deg
View Angle	(H)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		_	
	T rise			10		μs
Response Time	T fall			10		μs
Display with 50% check Board Brightness			60	80		cd/m2
CIEx(White)		(CIE1931)	0.26	0.28	0.30	
CIEy(White)	(CIE1931)	0.30	0.32	0.34		







8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25℃ / Initial 50% check board brightness Typical Value	20,000 Hrs	_	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.



9.Reliability

Content of Reliability Test

Environmenta	I Test		
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80 °C 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80 °C 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40 °C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90% RH 240hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 30min 5min 30min 1 cycle	-40 °C ⁄80°C 100 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr	
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction	
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	
Others			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact) ±800v(air), RS=330Ω CS=150pF 10 times),

*** Supply voltage for OLED system =Operating voltage at 25° C



Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.





10.Inspection Specification

NO	Item	Criterion					AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 			0.65		
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≦0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm. 			2.5		
03	OLED black spots, white spots, contamina tion (non-displ ay)	3.1 Round type following drawin $\Phi=(x + y)/2$			SIZE $\Phi \le 0.10$ $0.10 <$ $\phi \le 0.20$ $0.20 <$ $\Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0	2.5
		3.2 Line type : (/	As followin Length L≦3.0 L≦2.5 	Wie W = 0.0 0.0	• /	Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are vis judge using blac specifications, n to find, must che specify direction	k spot ot easy eck in	Φ 0.2 0.5	x = Φ ≤ 0.20 20 < Φ ≤ 0.50 50 < Φ ≤ 1.00 00 < Φ tal Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

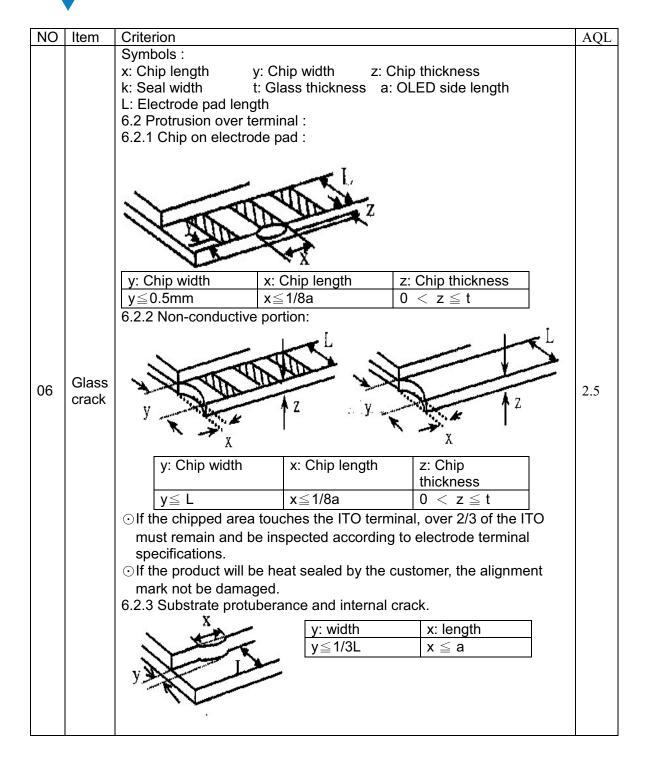
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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination			
			t: Glass thickness a	Chip thickness : OLED side length	
		6.1 General glass ch 6.1.1 Chip on panel s	ip : surface and crack betw X	ween panels:	
				y i the	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x≦1/8a	2.5
	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a	
		6.1.2 Corner crack:	bre chips, x is total ler		
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x≦1/8a	
		$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a	
		\odot If there are 2 or mo	ore chips, x is the tota	l length of each chip.	

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NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	 2.5 2.5 2.5 2.5 0.65 0.65 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65



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NO	Item	Criterion	AQL
		 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 	2.5 0.65
		12.3 No contamination, solder residue or solder balls on	2.5 2.5
		product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the	2.5 2.5
12	General	interface pin must be present or look as if it cause the interface pin to sever.	2.5
12	appearance	12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5 0.65
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	0.65



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Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	Image: state

Revision: 14-Dec-16



11.Precautions in use of OLED Modules

Modules

- (1)Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the
- components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8)It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9)Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10) Vishay has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) Vishay have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay have the right to modify the version.)

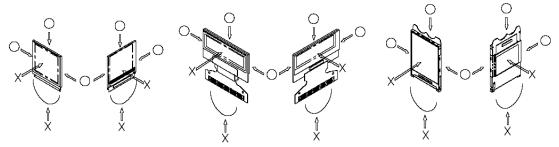
11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent
 - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent
 - such as ethyl alcohol, since the surface of the polarizer will become cloudy.
 - Also, pay attention that the following liquid and solvent may spoil the polarizer:
 - * Water
 - * Ketone
 - * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



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(7) Do not apply stress to the LSI chips and the surrounding molded sections.

(8) Do not disassemble nor modify the OLED display module.

(9) Do not apply input signals while the logic power is off.

(10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.

- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

(11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.

(12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

11.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from Vishay.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

11.3. Designing Precautions

(1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
 (2) To provent excurrence of malfunctioning by point, now attention to extinct the VII. and V

(2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.

(3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)

(4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.

(5) As for EMI, take necessary measures on the equipment side basically.

23



(6) When fastening the OLED display module, fasten the external plastic housing section.

(7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.

* Connection (contact) to any other potential than the above may lead to rupture of the IC.

11.4. Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

11.5. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- * Pins and electrodes
- * Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7)Our company will has the right to upgrade and modify the product function.



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1